PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|------------|----------------|
| Akira TADA | 08/07/2008 |

RECEIVING PARTY DATA

| Name: | RENESAS TECHNOLOGY CORP. | |
|-----------------|------------------------------------|--|
| Street Address: | 6-2, Otemachi 2-chome, Chiyoda-ku, | |
| City: | Tokyo | |
| State/Country: | JAPAN | |
| Postal Code: | 100-0004 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12280074 |

CORRESPONDENCE DATA

Fax Number: (202)756-8087

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (202) 756-8623

Email: jwpatterson@mwe.com

Correspondent Name: Wes Patterson
Address Line 1: 600 13th St. N.W.

Address Line 4: Washington, DISTRICT OF COLUMBIA 20005

| ATTORNEY DOCKET NUMBER: | 067161-0504 |
|-------------------------|-------------|
| | |

NAME OF SUBMITTER: Brian K. Seidleck, 51,321

Total Attachments: 3

source=067161-0504Assignment+Trans#page1.tif source=067161-0504Assignment+Trans#page2.tif source=067161-0504Assignment+Trans#page3.tif

PATENT REEL: 021417 FRAME: 0900

500626101

CH \$40.00

| RECORDATION FORM COVER SHEET | | | | |
|--|---|--|--|--|
| Docket No.: 067161-0504 | | | | |
| To the Director of the U. S. Patent and Trademark Office: Please | record the attached documents or the new address(es) below. | | | |
| 1. Name of Conveying Party(ies) | 2. Name and address of receiving party(ies) | | | |
| Akira TADA | Name: RENESAS TECHNOLOGY CORP. | | | |
| | Internal Address: | | | |
| Additional name(s) of conveying party(ies) attached? Yes No | | | | |
| 3. Nature of Conveyance/Execution Date(s) | Address: 6-2, Otemachi 2-chome, Chiyoda-ku, | | | |
| Execution Date(s): August 7, 2008 | | | | |
| | Tokyo, 100-0004 JAPAN | | | |
| ☐ Security Agreement ☐ Change of Name | | | | |
| Joint Research Agreement | | | | |
| Government Interest Assignment | | | | |
| Executive Order 9424, Confirmatory License | | | | |
| ☐ Other | Additional name(s) & address(es) attached? Yes No | | | |
| 4. Application or patent number(s): | ☐ This document is being filed together with a new | | | |
| | application. | | | |
| A. Patent Application No(s). | B. Patent No(s). | | | |
| | | | | |
| | | | | |
| | | | | |
| Additional numbers attac | hed? Yes No | | | |
| 5. Name and address to whom correspondence concerning | 6. Total number of applications and patents 1 | | | |
| document should be mailed: | involved: | | | |
| Name: MCDERMOTT WILL & EMERY LLP | 7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00 | | | |
| Internal Address: | Authorized to be charged by credit card | | | |
| | Authorized to be charged to deposit account | | | |
| Street Address: 600 13th Street, N.W. | ☐ Enclosed | | | |
| | None required (government interest not affecting title) | | | |
| City: Washington State: D. C. Zip: 20005-3096 | | | | |
| Phone Number: 202.756.8000 | 8. Payment Information: | | | |
| Fax Number: 202.756.8087 | | | | |
| Email Address: | a. Credit Card Last 4 Numbers | | | |
| | Expiration Date b. Deposit Account Number 500417 | | | |
| | Authorized User Name | | | |
| | | | | |
| 9. Signature. Line K. Link Res. No. 51 | 32/ | | | |
| Bernard P. Codd, 46,429 | August 20, 2008 | | | |
| Name and Registration No. of Person Signing | Signature Date | | | |
| Total number of pages includi | ng cover sheet, attachments and documents: 3 | | | |
| | | | | |

PATENT REEL: 021417 FRAME: 0901

| Automey Docket No | | | |
|--|--|--|--|
| | ASSIGNMENT | | |
| | 6, Akira TADA, hereinafter called the "Assignor," has invented a new n entitled Semiconductor Device, for which he has: | | |
| (a) | filed an application for United States Letters Patent on as (Serial No); or | | |
| (b) | executed an application for United States Letters Patent on August 7, 2008; or | | |
| (c) | filed a provisional application on as (Serial No); and | | |
| under the la 6-2, Otema called the "A and to said Letters Pate | Renesas Technology Corp., a corporation organized and existing ws of <u>Japan</u> , having a place of business at: achi 2-chome, Chiyoda-ku, Tokyo 100-0004 Japan, hereinafter Assignee," is desirous of acquiring the entire right, title and interest in invention, the application above identified, and in, to and under any ent which may be obtained to said invention, as hereinafter more fully | | |
| set forth; | | | |

NOW. THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient considerations, the receipt of which by said Assignor from the said Assignee is hereby acknowledged, the said Assignor has sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignee, the entire, right, title and interest for the United States in and to the invention and application hereinabove identified, and any Letters Patent of the United States that may issue for said invention, together with the entire right, title and interest in and to said invention and applications for Letters Patent and Letters Patent therefor, in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; to have and to hold for the sole and exclusive use and benefit of the said Assignee, its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said inventions may issue.

> **PATENT** REEL: 021417 FRAME: 0902

ter in

lly

And the said Assignor does hereby covenant and agree, for himself and his legal representatives, that he will assist the said Assignee in the prosecution of the application herein identified; in the making and prosecution of any other applications for Letters Patent that the said Assignee may elect to make covering the invention herein identified, as hereinabove set forth; in vesting in the said Assignee like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that they will execute and deliver to the said Assignee any and all additional papers which may be requested by the said Assignee to fully carry out the terms of this Assignment.

The undersigned hereby grant(s) the attorneys of McDermott, Will & Emery LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

And the Commissioner of Patents and Trademarks is hereby authorized and requested to issue Letters Patent to the said Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the said Assignor has hereunto set his hands and affixed his seal.

| Date: | August 7, 2008 | | Ahira | Jada | (Seal |
|-------|----------------|---------------------------|------------|------|-------|
| | | - | Akira TADA | | |

PATENT REEL: 021417 FRAME: 0903

- 2 -